



Att. Dkt. No.: AMK-11313 (M-11313 US)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Donald Craig Foster

Application No.: 09/932,290

Art Unit.: 2827

Filing Date: 08/17/2001

Examiner: David E. Graybill

For: "SEMICONDUCTOR PACKAGE AND LEADFRAME WITH HORIZONTAL
LEADS SPACED IN THE VERTICAL DIRECTION AND METHOD OF MAKING"

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Date: October 8, 2003

AMENDMENT TRANSMITTAL

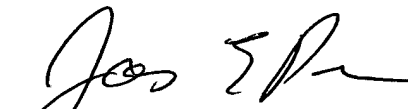
1. Transmitted herewith is an amendment for this application.
2. **STATUS:** Applicant is other than a small entity.
3. **EXTENSION OF TERM:** The proceedings herein are for a patent application and the provisions of 37 C.F.R. 1.136 apply. Applicant believes that no extension of term is required. However, this conditional petition is being made to provide for the possibility that applicant has inadvertently overlooked the need for a petition for extension of time.
4. **FEE FOR CLAIMS:** The fee for claims (37 C.F.R. 1.16(b)-(d)) has been calculated as shown below:

	(Col.1)		(Col. 2)	(Col. 3)	LARGE ENTITY	
	Claims Remaining After Amendment		Highest No. Previously Paid For	Present Extra	Rate	Addit. Fee
Total	52	Minus	34	= 18	x \$18 =	\$324
Indep.	5	Minus	5	= 0	x \$86 =	\$0
First Presentation of Multiple Dependent Claim					+ \$290 =	\$0
Total						\$324
Addit. Fee						\$324

5. **FEE PAYMENT and DEFICIENCY:** Please charge Deposit Acct. 50-0574 the amount of \$324.00 for additional claims. If any additional extension and/or fee is required, also charge Account No. 50-0574.

Customer No. 022888

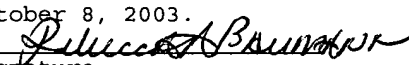
Tel.: (408) 451-5906


SIGNATURE OF PRACTITIONER
James E. Parsons
Reg. No. 34,691

I hereby certify that this correspondence is being deposited with the
United States Postal Service as FIRST CLASS MAIL in an envelope
addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria,
VA 22313-1450, on October 8, 2003.

Date

Signature

10/8/03




IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Donald Craig Foster
Assignee: Amkor Technology, Inc.
Title: Semiconductor Package And Leadframe With
Horizontal Leads Spaced In The Vertical Direction
And Method Of Making
Serial No.: 09/932,290-4763 File Date: August 17, 2001
Examiner: Graybill, David E. Art Unit: 2827
Docket No.: AMK-11313 (formerly M-11313 US)

Date: October 8, 2003

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT IN RESPONSE TO THE OFFICE ACTION OF 9/11/03

Dear Sir:

In response to the Office Action mailed from the Patent Office on September 11, 2003, please amend the claims as indicated and please consider the following remarks.

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